B. Losee from B. LaRoy 6 Dec. 1990

Validation runs of the simplified heat transfer model indicated that improved spatial resolution will be required to accurately assess thin layers of candidate heater support materials. Work is in progress (Sung Yi) to increase the number of points at which temperature is calculated while keeping computer run times within practical bounds.

The patent status of the beta program was reviewed by program personnel and patent council. Recommendations were developed for expediting current items on the R&D Docket by (1) combining similar disclosures, (2) entering some items as continuations in part to existing applications and/or (3) technical reassessment of selected items. Areas where patent coverage might be improved were identified and disclosures will be prepared for further discussion.

The operational plans of the program will be reviewed during the first quarter of 1991 with the primary objective of strengthening longer term strategies.

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